



PATENT

Atty. Dkt. No. AMAT/5335.C1/CPI/COPPER/PJS

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Chen, et al.

Serial No.: 10/625,480

Confirmation No.: 9106

Filed: July 22, 2003

For: CVD TiSin Barrier For
Copper Integration§
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Group Art Unit: 2818

Examiner: Phuc T. Dang

MAIL STOP AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

CERTIFICATE OF MAILING
37 CFR 1.8I hereby certify that this correspondence is being deposited on
11/30, 2004, with the United States Postal Service as
First Class Mail in an envelope addressed to: Commissioner
for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.11/30/04
Date[Signature]
Signature

RESPONSE TO OFFICE ACTION DATED AUGUST 31, 2004

In response to the Office Action dated August 31, 2004, having a shortened statutory period for response set to expire on November 30, 2004, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/ AMAT/5335.C1/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

Amendments to the Specification begin on page 2 of this paper. **Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of this paper. **Remarks** begin on page 5 of this paper.